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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Charles W. Eichelberger Batch No.: E89

Serial No.: 08/650,628 Group Art Unit: 2811

Filed: 05/20/96 Examiner: Potter, R.

Title: SINGLE CHIP MODULES, REPAIRABLE MULTICHIP MODULES,

AND METHODS OF FABRICATION THEREOF

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the U.S. Postal Service as first class mail in an envelope addressed to: Box ISSUE FEE, Assistant Commissioner for Patents, Washington, D.C. 20231, on August 31, 1998.

Kevin P. Radigan Attorney for Applicant Reg. No. 31,789

Date of Signature: August 3(, 1998

To: Box ISSUE FEE

Assistant Commissioner for Patents

Washington, D.C. 20231

Attention: Official Draftsman

Dear Sir:

Enclosed please find eleven (11) sheets of formal drawings with reference to the above entitled patent application. In sheet 11/11, the previously objected to stippling has been

removed from Figs. 9c-9e. Approval of the enclosed formal drawings is therefore requested.

Respectfully submitted,

Kevin P. Radigan Reg. No. 31,789

Dated: August 31 , 1998

HESLIN & ROTHENBERG, P.C. 5 Columbia Circle

Albany, New York 12203 Telephone: (518) 452-5600 Facsimile: (518) 452-5579

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Kevin P. Radigan O Attorney for Applicant Reg. No. 31,789

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Enclosed: Issue Fee Transmittal Letter

Official Draftsman Letter

Eleven (11) Sheets of Formal Drawings

\$660.00 Issue Fee

\$30.00 Advance Order Fee